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Fairchild Semiconductor FQP2N80

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Datasheet of FQP2N80 - MOSFET N-CH 800V 2.4A TO-220 Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



November 2013

FQP2N80

N-Channel QFET $^{(\!R\!)}$ MOSFET 800 V, 2.4 A, 6.3 Ω

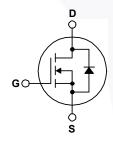
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 2.4 A, 800 V, $R_{DS(on)}$ = 6.3 Ω (Max.) @ V_{GS} = 10 V, I_D = 1.2 A
- Low Gate Charge (Typ. 12 nC)
- Low Crss (Typ. 5.5 pF)
- · 100% Avalanche Tested





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQP2N80	Unit
V_{DSS}	Drain-Source Voltage		800	V
I _D	Drain Current - Continuous (T _C = 25°	C)	2.4	Α
	- Continuous (T _C = 100	°C)	1.52	A
I _{DM}	Drain Current - Pulsed	(Note 1)	9.6	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	180	mJ
I _{AR}	Avalanche Current	(Note 1)	2.4	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	8.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.0	V/ns
P _D	Power Dissipation (T _C = 25°C)		85	W
	- Derate above 25°C		0.68	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQP2N80	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.47	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	



Datasheet of FQP2N80 - MOSFET N-CH 800V 2.4A TO-220

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQP2N80	FQP2N80	TO-220	Tube	N/A	N/A	50 units

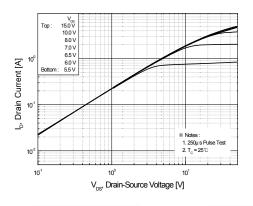
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA				V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.9		V/°C
I _{DSS}	Zero Code Vellana Brain Consul	V _{DS} = 800 V, V _{GS} = 0 V			10	μΑ
	Zero Gate Voltage Drain Current	V _{DS} = 640 V, T _C = 125°C			100	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 1.2 A		4.9	6.3	Ω
g _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 1.2 A		2.65		S
C _{iss}	Input Capacitance Output Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz		425 45	550 60	pF pF
	<u>'</u>	50 . 00 .				•
C _{rss}	Reverse Transfer Capacitance			5.5	7.0	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 400 V, I _D = 2.4 A,		12	35	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		30	70	ns
$t_{d(off)}$	Turn-Off Delay Time			25	60	ns
t _f	Turn-Off Fall Time	(Note 4)	/	28	65	ns
Q_g	Total Gate Charge	V _{DS} = 640 V, I _D = 2.4 A,		12	15	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V	/	2.6		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		6.0		nC
Drain-S	Source Diode Characteristics a	nd Maximum Ratings			y	
I _S					2.4	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				9.6	Α
		V _{GS} = 0 V, I _S = 2.4 A			1.4	V
	Drain-Source Diode Forward Voltage	VGS - U V, IS - 2.4 A			1.4	v
V _{SD}	Drain-Source Diode Forward Voltage Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_S = 2.4 \text{ A}$		480		ns

- **Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature. 2. L = 59 mH, I_{AS} = 2.4 A, V_{DD} = 50 V, R_{Q} = 25 Ω , starting T_{J} = 25°C. 3. $I_{SD} \leq$ 2.4 A, $di/dt \leq$ 200 A/ μ s, $V_{DD} \leq$ BV $_{DSS}$, starting T_{J} = 25°C. 4. Essentially independent of operating temperature.



Typical Characteristics



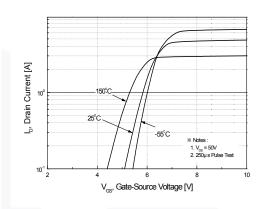
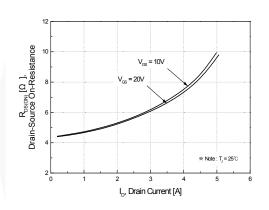


Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



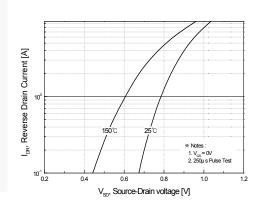
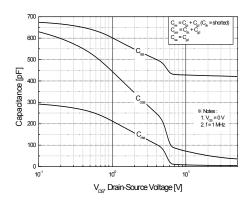


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature



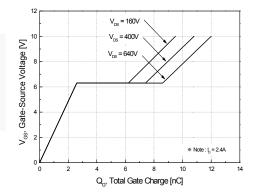
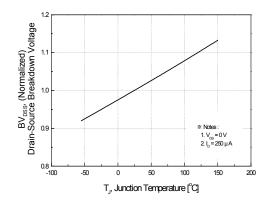


Figure 5. Capacitance Characteristics

Figure 6. Gate Charge Characteristics



Typical Characteristics (continued)



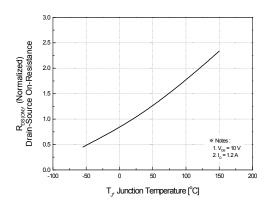
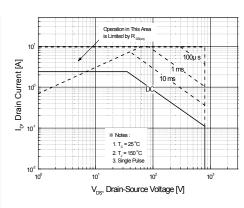


Figure 7. Breakdown Voltage Variation vs Temperature

Figure 8. On-Resistance Variation vs Temperature



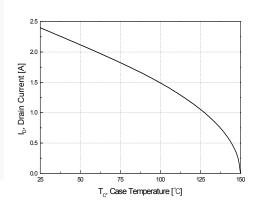


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

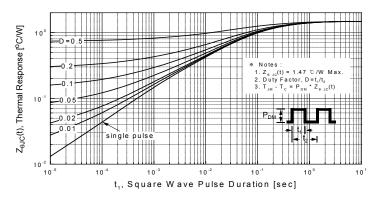


Figure 11. Transient Thermal Response Curve

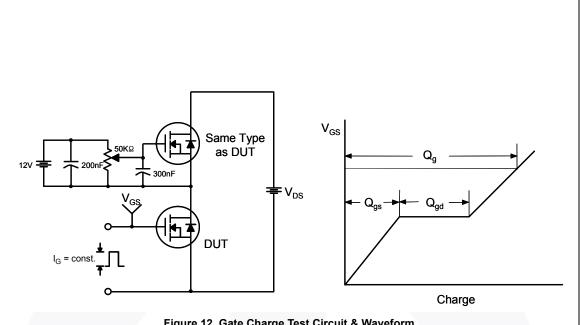


Figure 12. Gate Charge Test Circuit & Waveform

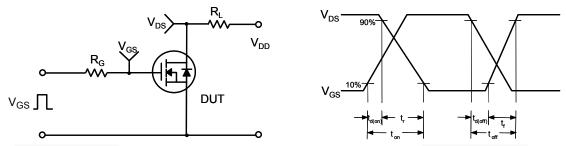


Figure 13. Resistive Switching Test Circuit & Waveforms

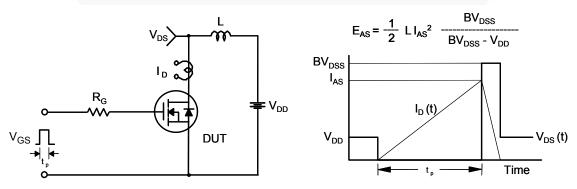
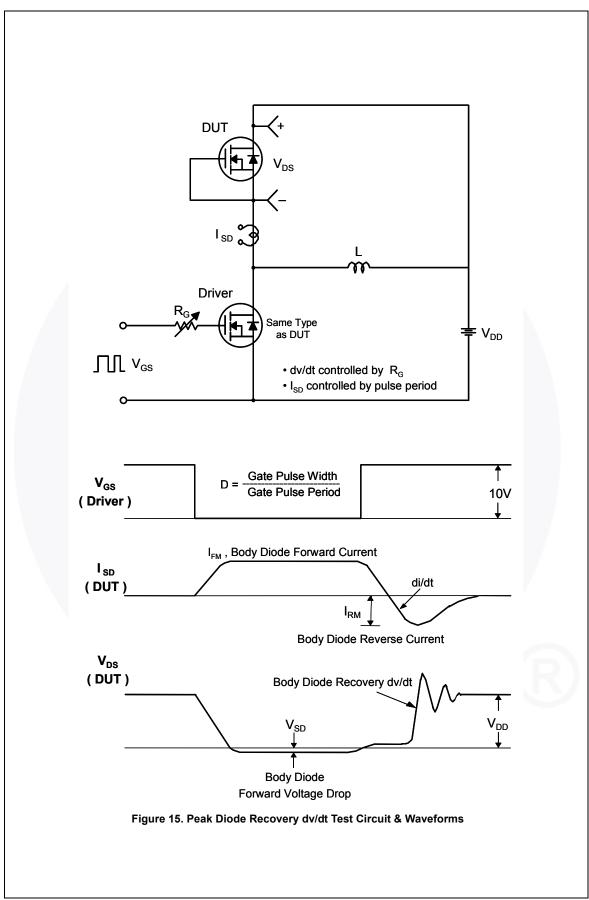


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





Mechanical Dimensions

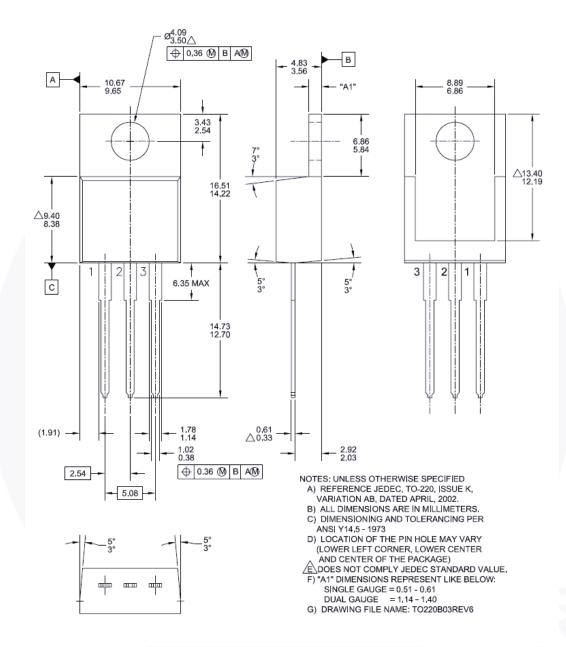


Figure 16 TO-220, Molded, 3-Lead, Jedec Variation AB

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